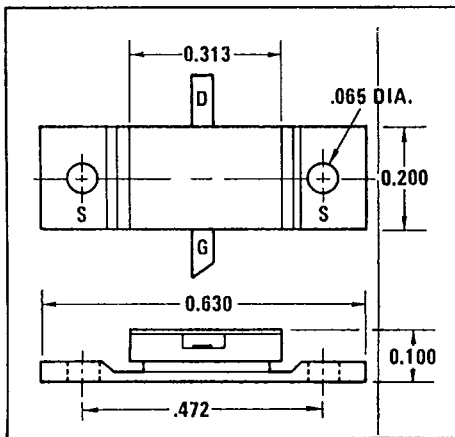


T-39-11

RPS2030 S-Band Power FET

- High breakdown voltage
- Stability under all DC bias and operating conditions
- Resistance to burn-out caused by RF over-drive or mismatch
- Exclusive "via hole" source connections
- Low thermal resistance
- Integral plated heat sink
- Dielectric passivation

TYPE 01
HERMETICALLY-SEALED PACKAGE



MAXIMUM RATINGS RPS2030

PARAMETER	SYMBOL	LIMIT
Drain — Source voltage	V_{DS}	15 V
Gate — Drain voltage	V_{GD}	-10 V
Gate — Source voltage	V_{GS}	-10 V
Total Power Dissipation	P_T	50 W
Channel Temperature	T_{CH}	+175° C
Storage Temperature	T_{STG}	-65° C to +176° C

Parameter	Symbol	Test Conditions	MIN	TYP	MAX	UNIT
Saturated Drain Current	I_{DSS}	$V_{DS} = 5 V, V_{GS} = 0 V$	3200	4800	7200	MA
Pinch-Off Voltage	V_P	$V_{DS} = 5 V, I_{DS} = 4\% \text{ of } I_{DSS} \text{ typ}$	3	5	8	V
Transconductance	g_m	$V_{DS} = 5 V$ $V_{GD} = -0.5 \text{ to } -1.0 V$	800	1200		MMO
Output Power	P_O	$V_{DS} = 10 V, I_{DS} \approx 0.5 I_{DSS}$ $f = 2.5 \text{ GHz}$	39	40		dBm
Gain at Rated Power	G_O	$V_{DS} = 10 V, I_{DS} \approx 0.5 I_{DSS}$ $f = 2.5 \text{ GHz}$	8	10		dB